

# **TE0803 Test Board**

Revision: v.18

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#### TE0803 Test Board

Online version of this manual and other related documents can be found at https://wiki.trenz-electronic.de /display/PD/Trenz+Electronic+Documentation

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# **Overview**

Design Example with minimum PS Setup (DDR, QSPI, UART0) only for custom boards or easier debug via SDK.

# **Key Features**

- QSPI
- SDK
- Custom Carrier (with other MIO settings as TEBF0808)

# **Revision History**

Date	Vivado	Project Built	Authors	Description
2017- 11-16	2017.2	TE0803-test_board-vivado_2017.2-build_05_20171116152716.zip TE0803-test_board_noprebuilt-vivado_2017.2-build_05_20171116154619.zip	John Hartfiel	Update Board Part CSV File with new Flash assembly variants
2017- 11-14	2017.2	TE0803-test_board-vivado_2017.2-build_05_20171114090712.zip TE0803-test_board_noprebuilt-vivado_2017.2-build_05_20171114090725.zip	John Hartfiel	Initial release

## **Release Notes and Know Issues**

Issues	Description	Workaround	To be fixed version
No known issues			

# Requirements

### **Software**

Software	Version	Note
Vivado	2017.2	needed
SDK	2017.2	needed

### **Hardware**

Basic description of TE Board Part Files is available on TE Board Part Files.

Complete List is available on <design name>/board\_files/\*\_board\_files.csv



Design supports following modules:

Module Model	Board Part Short Name	PCB Revision Support	Notes
TE0803-ES1	es1	REV01	
TE0803-01-02EG-1E	2eg	REV01	
TE0808-2ES2	2es2	REV01	
TE0803-01-02CG-1E / *EA	2cg	REV01	/ different QSPI Flash size
TE0803-01-03EG-1E / *EA	3eg	REV01	/ different QSPI Flash size
TE0803-01-03CG-1E / *EA	3cg	REV01	/ different QSPI Flash size

Note: Design contains also Board Part Files for TE0803+TEBF0808 configuration, this boart part files are not used for this reference design. \* Only different Flash size.

Design supports following carriers:

Carrier Model	Notes
Custom PCB	use simple Board Part files, if MIO connected is different to TEBF0808
TEBF0808	Used as reference carrier.
TEBT0808	Change UART0 to UART1 (MIO6869) and regenerate design

### Additional HW Requirements:



## Content

For general structure and of the reference design, see Project Delivery

# **Design Sources**

Туре	Location	Notes
Vivado	<pre><design name="">/block_design <design name="">/constraints <design name="">/ip_lib</design></design></design></pre>	Vivado Project will be generated by TE Scripts
SDK/HSI	<design name="">/sw_lib</design>	Additional Software Template for SDK/HSI and apps_list.csv with settings for HSI

### **Additional Sources**

Type	Location	Notes

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## **Prebuilt**

File	File-Extension	Description
BIF-File	*.bif	File with description to generate Bin-File
BIN-File	*.bin	Flash Configuration File with Boot-Image (Zynq-FPGAs)
BIT-File	*.bit	FPGA (PL Part) Configuration File
Diverse Reports		Report files in different formats
Hardware-Platform-Specification-Files	*.hdf	Exported Vivado Hardware Specification for SDK/HSI and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

### **Download**

Reference Design is only usable with the specified Vivado/SDK/PetaLinux/SDx version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

TE0803 Test Board



# **Design Flow**



Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

#### See also:

- Vivado/SDK/SDSoC#XilinxSoftware-BasicUserGuides
- Vivado Projects
- Project Delivery.

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "\_create\_win\_setup.cmd" on Windows OS and "\_create\_linux\_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/SDK GUI. For currently Scripts limitations on Win and Linux OS see: Project Delivery Currently limitations of functionality

1. \_create\_win\_setup.cmd/\_create\_linux\_setup.sh and follow instructions on shell:

- 2. Press 0 and enter for minimum setup
- (optional Win OS) Generate Virtual Drive or use short directory for the reference design (for example x:\<design name>)
- 4. Create Project
  - a. Select correct device and Xilinx install path on "design\_basic\_settings.cmd" and create Vivado project with "vivado\_create\_project\_guimode.cmd"

Note: Select correct one, see TE Board Part Files

Use Board Part Files, which did not contains with \*\_tebf0808

5. Create HDF and export to prebuilt folder

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- a. Run on Vivado TCL: TE::hw\_build\_design -export\_prebuilt
   Note: Script generate design and export files into \prebuilt\hardware\<short dir>. Use GUI is the same, except file export to prebuilt folder
- 6. Generate Programming Files with HSI/SDK
  - a. Run on Vivado TCL: TE::sw\_run\_hsi

    Note: Scripts generate applications and bootable files, which are defined in "sw\_lib\apps\_list.

    csv"
  - b. (alternative) Start SDK with Vivado GUI or start with TE Scripts on Vivado TCL: TE:: sw\_run\_sdk

Note: See SDK Projects



## Launch

## **Programming**



Check Module and Carrier TRMs for proper HW configuration before you try any design.

Xilinx documentation for programming and debugging: Vivado/SDK/SDSoC-Xilinx Software Programming and Debugging

### **QSPI**

- 1. Select JTAG as Boot Mode (see Carrier Description and ZynqMP TRM)
- 2. Connect JTAG to Host PC
- 3. Power On
- 4. Open Vivado Hardware Manager with Auto Connect
- 5. Right Click to FPGA Device XCU... and select Add Configuration Memory Device
  - a. Select correct Flash Typ (see schematics or FPGAFLASHTYP on test\_board/board\_files /TE0808\_board\_files.csv)
- 6. Open Program Configuration Memory Device
  - a. Configuration file: test\_board/prebuilt/boot\_image/<short dir>/hello\_te0803/Boot.bin
  - b. Zynq FSBL: test\_board/prebuilt/software/<short dir>/zynqmp\_fsbl.elf
  - c. Program Device Flash

Use SDK instead of Vivado is also possible, see: SDK Projects#Xilinx%22HelloWorld%22onZyngMP

#### SD

This does not work, because SD controller is not selected on PS.

#### **JTAG**

Load configuration and Application with SDK Debugger into device, see:

- SDK Projects
- SDK Projects#DebugSoftwareApplication

## **Usage**

#### **QSPI** Boot:

- 1. Prepare HW like described on section Programming
- 2. Connect UART USB (most cases same as JTAG)

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3. Select QSPI Card as Boot Mode

Note: See TRM of the Carrier, which is used.

4. Power On PCB

Note: 1. ZynqMP Boot ROM loads PMU Firmware and FSBL from QSPI into OCM, 2. FSBL loads

Application into DDR

## Debugging:

- SDK Projects
- SDK Projects#DebugSoftwareApplication



# **System Design - Vivado**

# **Block Design**



### **PS Interfaces**

Activated interfaces:

Туре	Note
DDR	
QSPI	MIO
UART0	MIO, please select other one, if you have connected uart to second controller or other MIO

## **Constrains**

## **Basic module constrains**

```
_i_bitgen.xdc

set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]

set_property BITSTREAM.CONFIG.UNUSEDPIN PULLNONE [current_design]
```

# Design specific constrain

Not needed.



# **Software Design - SDK/HSI**

For SDK project creation, follow instructions from:

**SDK Projects** 

# **Application**

### **FSBL**

Xilinx default FSBL

## Hello TE0803

Hello TE0803 is a Xilinx Hello World example as endless loop instead of one console output.



# **Additional Software**

No additional software is needed.



# Appx. A: Change History and Legal Notices

## **Document Change History**

To get content of older revision got to "Change History" of this page and select older document revision number.

Date	Document Revision	Authors	Description
2018-10-	018-10- v.18 John Hartfiel		<ul> <li>Update assembly versions with new</li> </ul>
26	Unbekanntes Makro: 'metadata'		Flash size
2017-11- 14	v.3	John Hartfiel	• Release 2017.2
	All	John Hartfiel , Thorsten Trenz	

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